

DGT305SE

Gate Turn-off Thyristor

DS5519-4 July 2014 (LN31740)

FEATURES

- Double Side Cooling
- High Reliability In Service
- High Voltage Capability
- Fault Protection Without Fuses
- High Surge Current Capability
- Turn-off Capability Allows Reduction In Equipment Size And Weight. Low Noise Emission Reduces Acoustic Cladding Necessary For Environmental Requirements

APPLICATIONS

- Variable speed A.C. motor drive inverters (VSD-AC)
- Uninterruptable Power Supplies
- High Voltage Converters
- Choppers
- Welding
- Induction Heating
- DC/DC Converters

KEY PARAMETERS

I _{тсм}	700A
V _{DRM}	1800V
I _{T(AV)}	240A
dV _D /dt	500V/ μs
di _T /dt	500Α/ μs

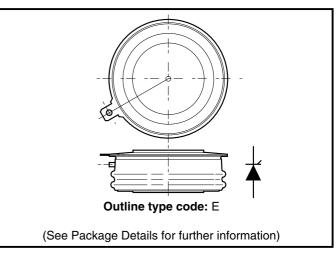


Fig. 1 Package outline

VOLTAGE RATINGS

Type Number	Repetitive Peak Off-state Voltage	Repetitive Peak Reverse Voltage	Conditions
	V _{DRM} V	V _{RRM} V	
DGT305SE18	1800	16	$T_{v_j} = 125^{\circ}C, I_{DM} = 50mA,$ $I_{RBM} = 50mA, V_{RG} = 2V$

CURRENT RATINGS

Symbol	Parameter	Conditions	Max.	Units
I _{TCM}	Repetitive peak controllable on-state current	$V_{\rm D} = 67\%V_{\rm DRM}, T_{\rm j} = 125^{\circ}C, di_{\rm GQ}/dt = 15A/\mu s, Cs = 1.5\mu F$	700	А
I _{T(AV)}	Mean on-state current	$T_{HS} = 80^{\circ}C$. Double side cooled. Half sine 50Hz.	240	А
I _{T(RMS)}	RMS on-state current	$T_{_{HS}} = 80^{\circ}$ C. Double side cooled. Half sine 50Hz.	373	А



SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I _{TSM}	Surge (non-repetitive) on-state current	10ms half sine. T _j = 125°C	4.0	kA
l²t	I ² t for fusing	10ms half sine. T _j =125°C	80000	A²s
di _r /dt	Critical rate of rise of on-state current	$V_{_{D}}$ = 67% $V_{_{DRM}},I_{_{T}}$ = 700A, $T_{_{j}}$ = 125°C, $I_{_{FG}}$ > 20A, Rise time < 1.0 μs	500	A/μs
dV _D /dt	Rate of rise of off-state voltage	To 80% V_{DRM} ; $R_{GK} \le 1.5\Omega$, $T_j = 125^{\circ}C$	500	V/µs
V _{DP}	Peak forward transient voltage during current fall time	$V_{_{D}} = 67\% V_{_{DRM}}, I_{_{T}} = 700A, T_{_{j}} = 125^{\circ}C, di_{_{GQ}}/dt = 15A/\mu s, Cs = 1.5\mu F$	400	V

GATE RATINGS

Symbol	Parameter	Conditions	Min.	Max.	Units
V _{RGM}	Peak reverse gate voltage	This value maybe exceeded during turn-off	-	16	V
I _{FGM}	Peak forward gate current		-	50	А
P _{FG(AV)}	Average forward gate power		-	10	w
P _{RGM}	Peak reverse gate power		-	6	kW
di _{gq} /dt	Rate of rise of reverse gate current		10	50	A/μs
t _{ON(min)}	Minimum permissable on time		20	-	μs
t _{OFF(min)}	Minimum permissable off time		40	-	μs

THERMAL RATINGS

Symbol	Parameter Conditions		Min.	Max.	Units	
		Double side cooled		-	0.075	°C/W
$R_{th(j-hs)}$	DC thermal resistance - junction to heatsink	Anode side cooled		-	0.12	°C/W
	surface	Cathode side cooled		-	0.20	°C/W
R _{th(c-hs)}	Contact thermal resistance	Clamping force 5.5kN With mounting compound	per contact	-	0.018	°C/W
T _{vj}	Virtual junction temperature		-	125	°C	
T _{OP} /T _{stg}	Operating junction/storage temperature range	torage temperature range		-40	125	°C
-	Clamping force		5.0	6.0	kN	



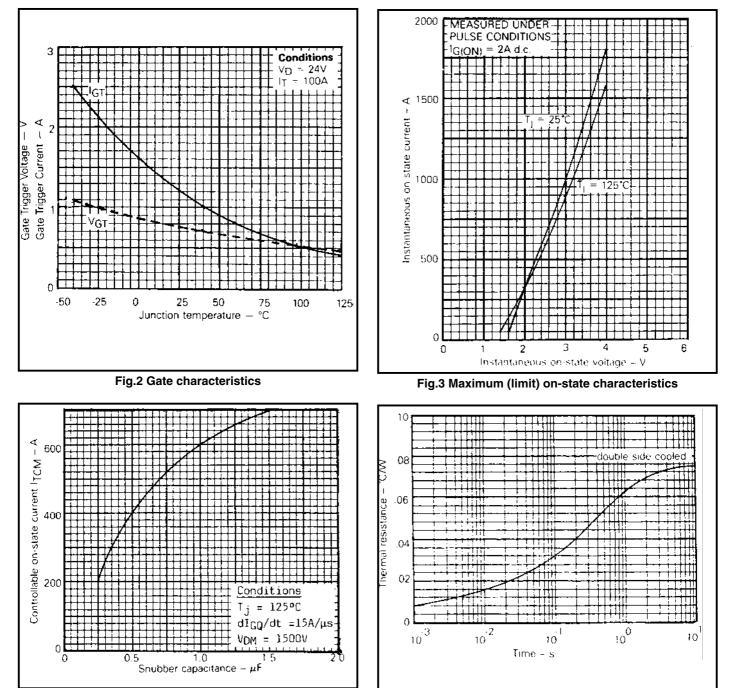
CHARACTERISTICS

Symbol	Parameter	Conditions		Max.	Units
V _{TM}	On-state voltage	At 600A peak, $I_{G(ON)} = 2A$ d.c.	-	2.5	V
I _{DM}	Peak off-state current	$At = V_{DRM}, V_{RG} = 2V$	-	50	mA
I _{RRM}	Peak reverse current	At V _{RRM}	-	50	mA
V _{gt}	Gate trigger voltage	$V_{\rm D} = 24V, I_{\rm T} = 100A, T_{\rm j} = 25^{\circ}{\rm C}$	-	0.75	V
Ι _{GT}	Gate trigger current	$V_{\rm D} = 24V, I_{\rm T} = 100A, T_{\rm j} = 25^{\circ}{\rm C}$	-	1.2	A
I _{RGM}	Reverse gate cathode current	$V_{RGM} = 16V$, No gate/cathode resistor	-	50	mA
E _{ON}	Turn-on energy	V _D = 1200V, I _T = 600A,	-	160	mJ
t _d	Delay time	I_{FG} = 20A, rise time < 1.0µs	-	1.1	μs
t _r	Rise time	$R_{L} = (Residual inductance 2.75 \mu H)$		2.5	μs
E	Turn-off energy		-	550	mJ
t_{tail}	Tail time		-	30	μs
t _{gs}	Storage time	I _T =600A, V _D = 1200V, Snubber Cap Cs = 1.5 μ F, di _{GQ} /dt = 15A/ μ s R ₁ = (Residual inductance 2.75 μ H)	-	12	μs
t _{gf}	Fall time		-	1.5	μs
t _{gq}	Gate controlled turn-off time		-	13.5	μs
Q _{GQ}	Turn-off gate charge	$n_L = (nesidual inductance 2.75 \mu n)$		900	μC
Q _{GQT}	Total turn-off gate charge		-	1800	μC

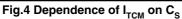
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CURVES







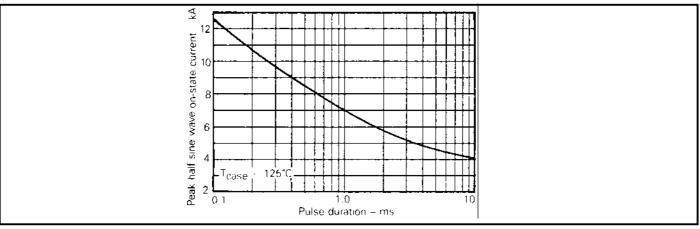


Fig.6 Surge (non-repetitive) on-state current vs time

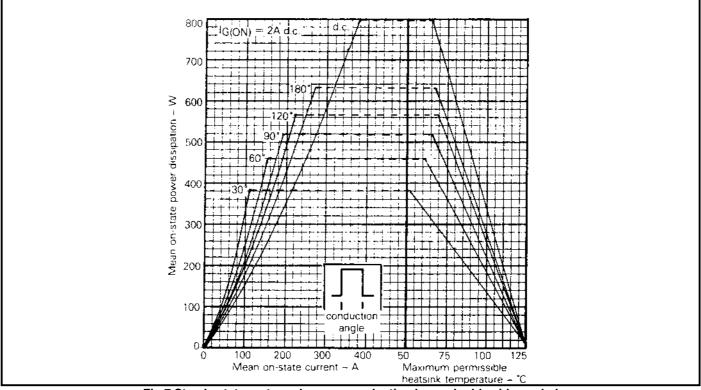


Fig.7 Steady state rectangulerwave conduction loss - double side cooled



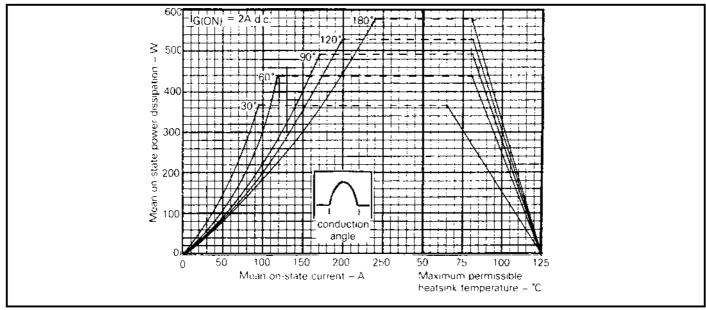


Fig.8 Steady state sinusoidal wave conduction loss - double side cooled

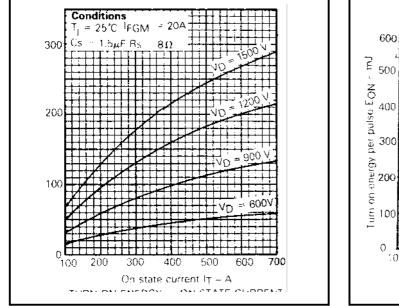


Fig.9 Turn-on energy vs on-state current

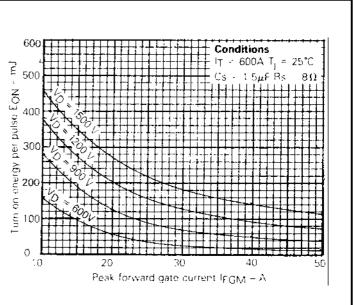


Fig.10 Turn-on energy vs peak forward gate current



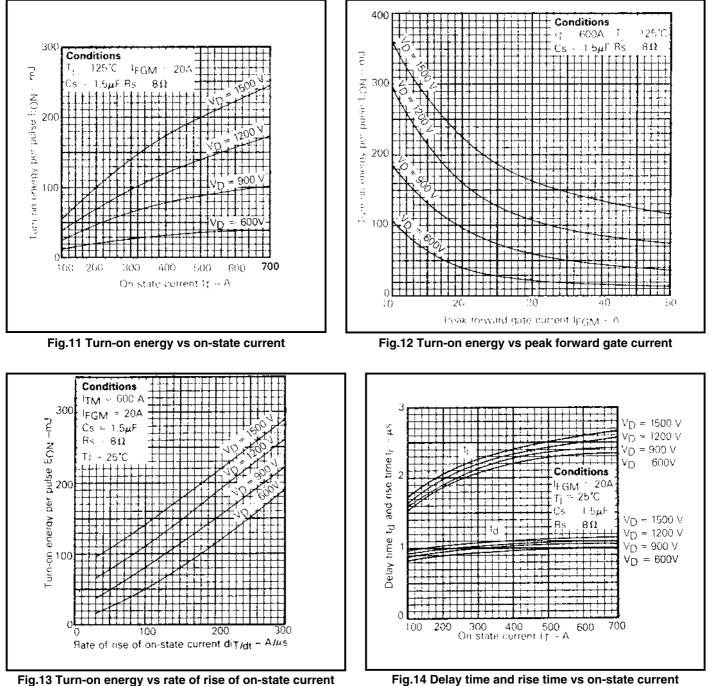
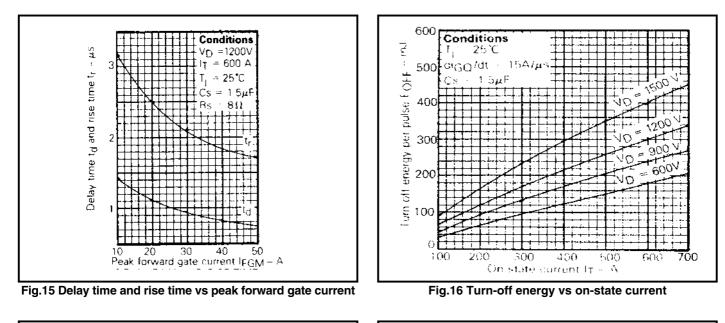


Fig.13 Turn-on energy vs rate of rise of on-state current





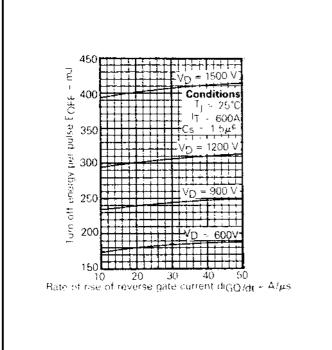


Fig.17 Turn-off energy vs rate of rise of reverse gate current

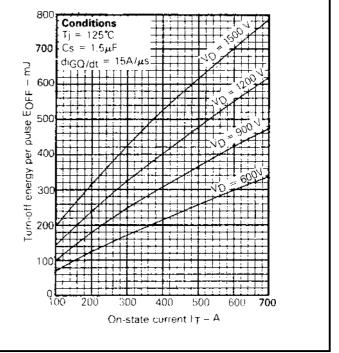


Fig.18 Turn-off energy vs on-state current



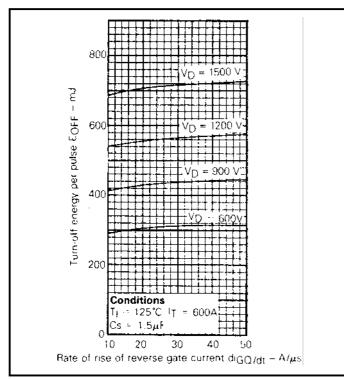


Fig.19 Turn-off energy vs rate of rise of reverse gate current

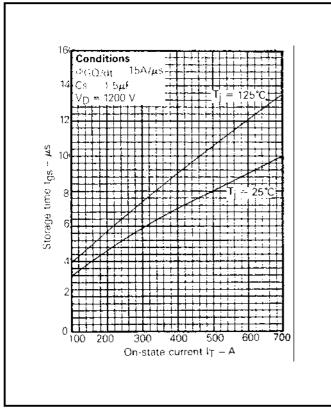


Fig.21 Storage time vs on-state current

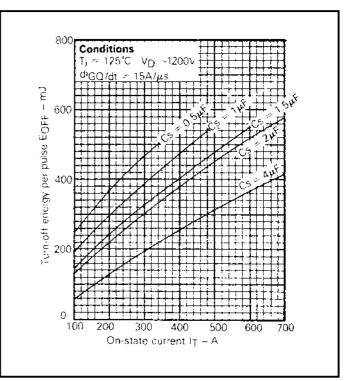


Fig.20 Turn-off energy vs on-state current with C_s as parameter

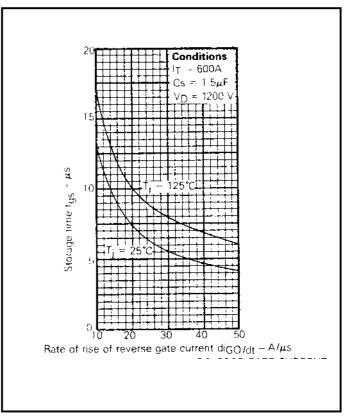


Fig.22 Storage time vs rate of rise of reverse gate current



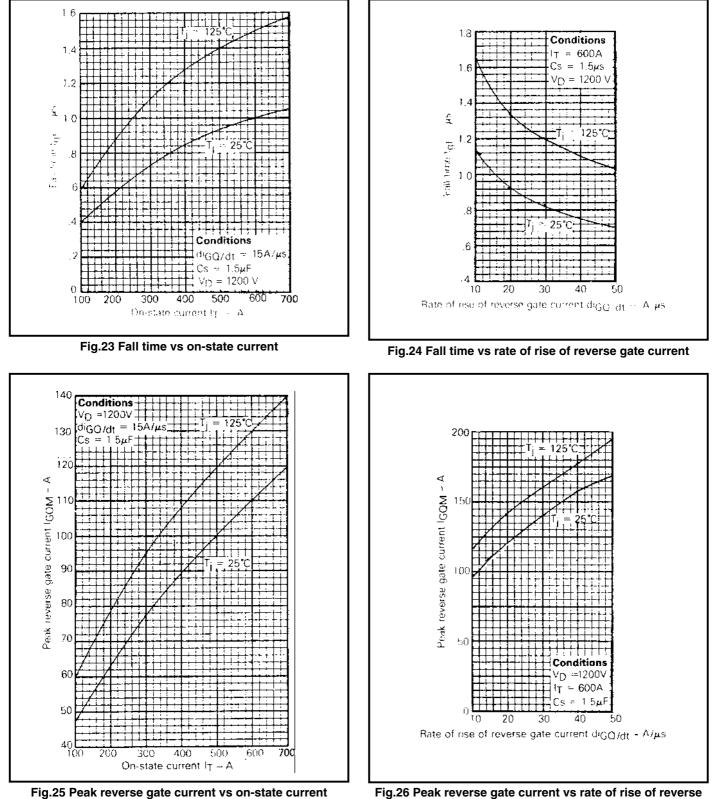


Fig.26 Peak reverse gate current vs rate of rise of reverse gate current



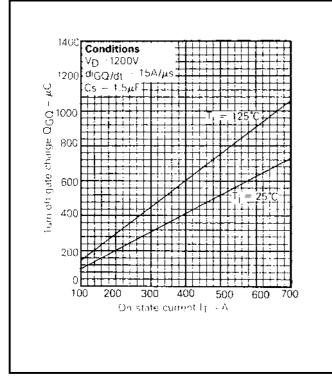


Fig.27 Turn-off gate charge vs on-state current

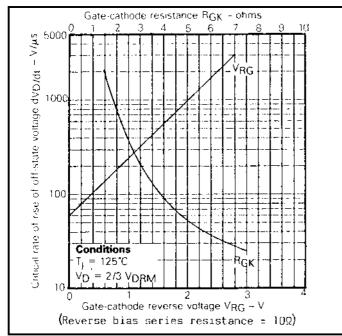


Fig.29 Dependence of critical dV_D/dt on gate-cathode resistance and gate-cathode reverse voltage

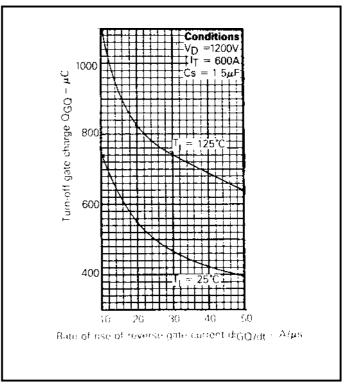


Fig.28 Turn-off gate charge vs rat of rise of reverse gate current

Snubber Capacitor Cs (µF)	Snubber Resistor Rs (Ω)	Minimum Reset Time (µs)
	7	35
2	5	30
	7	26
15	5	22
	7	17
1	5	15

Table of snubber discharge time variation with snubber capacitor value.



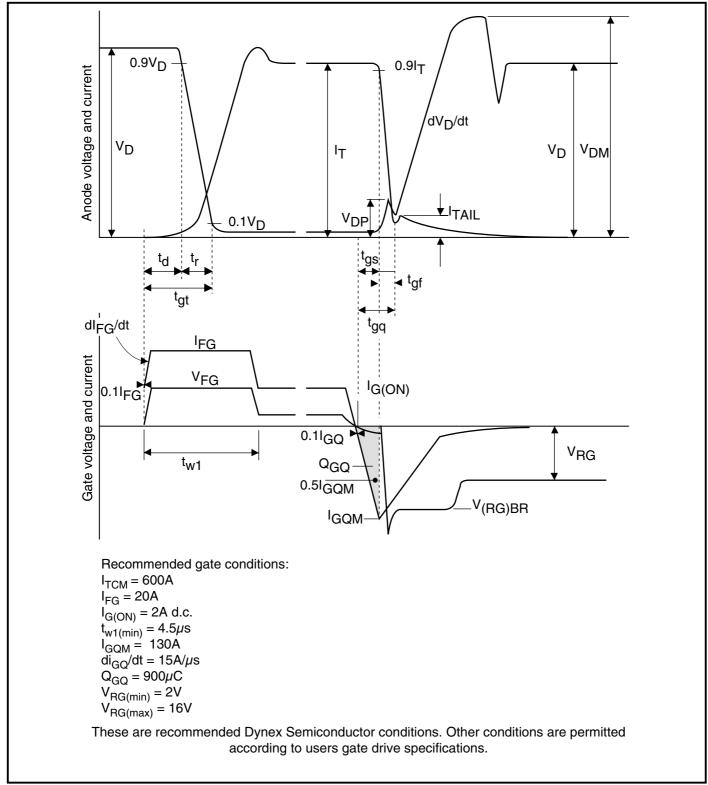
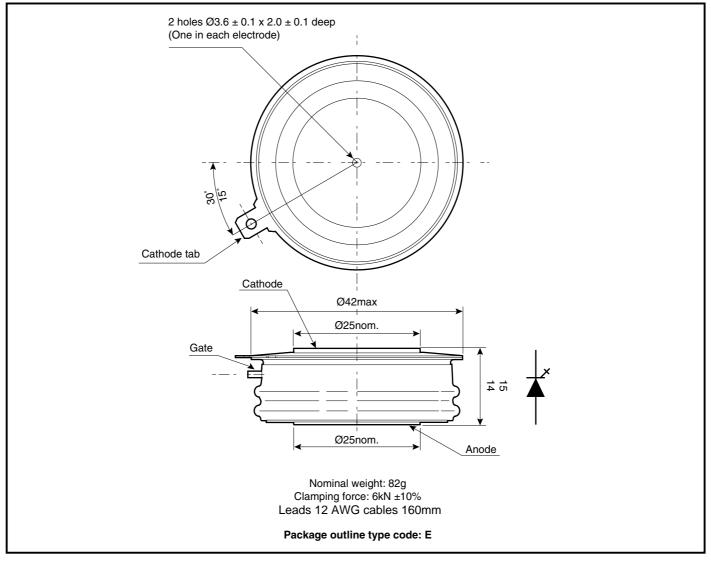


Fig.30 General switching waveforms



PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





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